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# HUF75645P3, HUF75645S3S

Data Sheet October 2013

# N-Channel UltraFET Power MOSFET 100 V, 75 A, 14 $m\Omega$

### **Packaging**

JEDEC TO-220AB

SOURCE
DRAIN
GATE

GATE

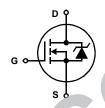
GATE

SOURCE
SOURCE
SOURCE

(FLANGE)

JF75645P3 HUF75645S3ST

### Symbol



#### **Features**

- · Ultra Low On-Resistance
- $-r_{DS(ON)} = 0.014\Omega, V_{GS} = 10V$
- · Simulation Models
  - Temperature Compensated PSPICE® and SABER™ Electrical Models
  - Spice and Saber Thermal Impedance Models
  - www.onsemi.com
- Peak Current vs Pulse Width Curve
- UIS Rating Curve

### Ordering Information

PART NUMBER	PACKAGE	BRAND
HUF75645P3	TO-220AB	75645P
HUF75645333T	TO 263AB	75645S

### Absolute Maximum Ratings T<sub>C</sub> = 25°C, Unless Otherwise Specified

	HUF75645P3, HUF75645S3ST	UNITS
Drain to Source Voltage (Note 1)	100	V
Drain to Gate Voltage (R $_{GS}$ = 20k $\Omega$ ) (Note 1)	100	V
Gate to Source Voltage	±20	V
Drain Current		
Drain Current Continuous ( $\Gamma_{C}$ = 25 $^{\circ}$ C, $V_{GS}$ = 10V) (Figure 2)	75	Α
Continuous ( $T_C = 100^{\circ}$ C, $V_{GS} = 10 \text{ V}$ ) (Figure 2)	65	Α
Pulsed Drain Current	Figure 4	
Pulsed Avalanche RatingUIS	Figures 6, 14, 15	
Power Dissipation P <sub>D</sub> Derale Above 25 <sup>o</sup> C	310	W
Derale Above 25°C	2.07	W/oC
Operating and Storage Temperature	-55 to 175	οС
Maximum Temperature for Soldering		
Leads at 0.063in (1.6mm) from Case for 10sT <sub>L</sub>	300	°С
Package Body for 10s, See Techbrief TB334	260	°C
NOTES:		

#### 1. $T_{.1} = 25^{\circ}C$ to $150^{\circ}C$ .

**CAUTION:** Stresses above those listed in "Absol24ute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

# HUF75645P3, HUF75645S3S

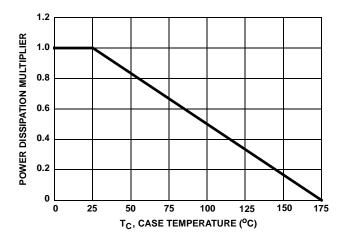
# **Electrical Specifications** $T_C = 25^{\circ}C$ , Unless Otherwise Specified

PARAMETER	SYMBOL	TEST CONDITIONS			TYP	MAX	UNITS	
OFF STATE SPECIFICATIONS								
Drain to Source Breakdown Voltage	BV <sub>DSS</sub>	$I_D = 250 \mu A, V_{GS} = 0 V$	100	-	-	V		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 95V, V <sub>GS</sub> = 0V		-	-	1	μΑ	
		V <sub>DS</sub> = 90V, V <sub>GS</sub> = 0V,	$T_{C} = 150^{\circ}C$	-	-	250	μА	
Gate to Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> = ±20V		-	-	±100	nA	
ON STATE SPECIFICATIONS								
Gate to Source Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS} = V_{DS}, I_D = 250\mu$	A (Figure 10)	2	-	4	٧	
Drain to Source On Resistance	r <sub>DS(ON)</sub>	I <sub>D</sub> = 75A, V <sub>GS</sub> = 10V (	Figure 9)	-	0.0115	0.014	Ω	
THERMAL SPECIFICATIONS							)	
Thermal Resistance Junction to Case	$R_{\theta JC}$	TO-220 and TO-263		-	17	0.48	oC/W	
Thermal Resistance Junction to Ambient	$R_{ heta JA}$		N	1/4	62	°C/W		
SWITCHING SPECIFICATIONS (VGS =	: 10V)			2				
Turn-On Time	t <sub>ON</sub>	$V_{DD} = 50V, I_{D} = 75A$		7.5		197	ns	
Turn-On Delay Time	t <sub>d</sub> (ON)	$V_{GS} = 10$ / $R_{GS} = 2.5\Omega$			14	-	ns	
Rise Time	t <sub>r</sub>	(Figures 18, 19)	M	117	-	ns		
Turn-Off Delay Time	t <sub>d</sub> (OFF)	12	E'OU'O	1	41	-	ns	
Fall Time	t <sub>f</sub>	CONCIORINI		-	97	-	ns	
Turn-Off Time	toff			-	-	207	ns	
GATE CHARGE SPECIFICATIONS		2/ 1/1/	10,					
Total Gate Charge	O <sub>g(TOT)</sub>	V <sub>GS</sub> = 0V to 20V	$V_{DD} = 50V$ ,	-	198	238	nC	
Gate Charge at 10V	Q <sub>g(10)</sub>	$V_{GS} = 0V \text{ to } 10V$	$I_D = 75A$ , $I_{g(REF)} = 1.0mA$	-	106	127	nC	
Threshold Gate Charge	Ci <sub>g(TH)</sub>	V <sub>GS</sub> = 0V to 2V (Figures 13, 16, 17)	-	6.8	8.2	nC		
Gate to Source Gate Charge	Q <sub>gs</sub>			-	14	-	nC	
Gate to Drain "Miller" Charge	Q <sub>gd</sub>			-	41	-	nC	
CAPACITATICE SPECIFICATIONS	7							
Input Capacitance	C <sub>ISS</sub>	$V_{DS} = 25V, V_{GS} = 0V,$ f = 1MHz (Figure 12)		-	3790	-	pF	
Output Capacitance	C <sub>OSS</sub>			-	810	-	pF	
Reverse Transfer Capacitance	C <sub>RSS</sub>			-	230	-	pF	

# **Source to Drain Diode Specifications**

PARAMETER	SYMBOL	TEST CONDITIONS		TYP	MAX	UNITS
Source to Drain Diode Voltage	V <sub>SD</sub>	I <sub>SD</sub> = 75A	-	-	1.25	V
		I <sub>SD</sub> = 35A	-	-	1.00	V
Reverse Recovery Time	t <sub>rr</sub>	$I_{SD} = 75A$ , $dI_{SD}/dt = 100A/\mu s$	-	-	145	ns
Reverse Recovered Charge	Q <sub>RR</sub>	$I_{SD} = 75A$ , $dI_{SD}/dt = 100A/\mu s$	-	-	360	nC

### **Typical Performance Curves**



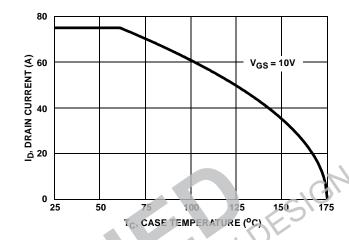


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

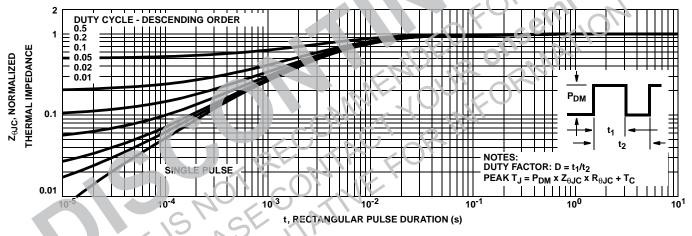
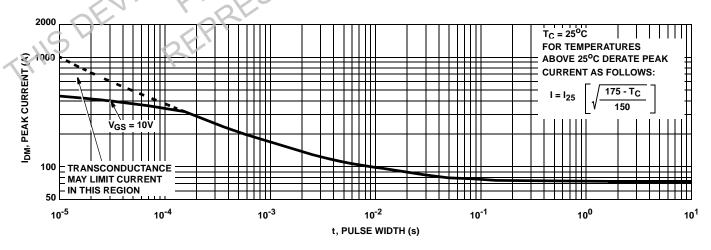


FIGURE 3. NORMALIZED MAXIMUM TRANSIENT THERMAL IMPEDANCE



**FIGURE 4. PEAK CURRENT CAPABILITY** 

### Typical Performance Curves (Continued)

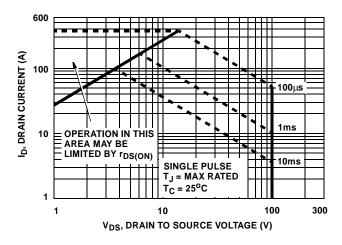


FIGURE 5. FORWARD BIAS SAFE OPERATING AREA

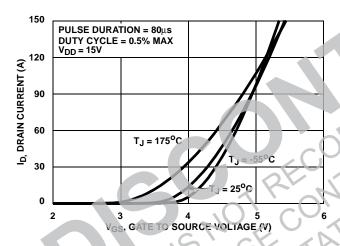


FIGURE 7. TRANSFER CHARACTERISTICS

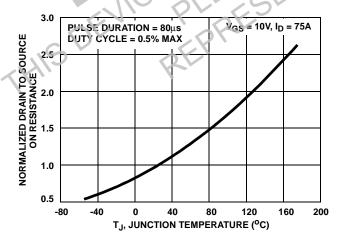
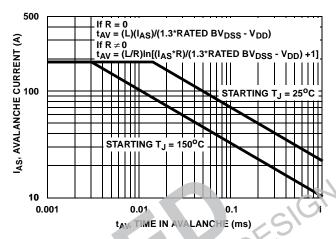


FIGURE 9. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE



NOTE: Refer to ON Semiconductor Application Notes AN9321 and AN9322.

FIGURE 6. UNCLAMPED INDUCTIVE SWITCHING CAPABILITY

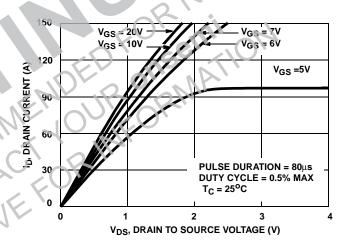


FIGURE 8. SATURATION CHARACTERISTICS

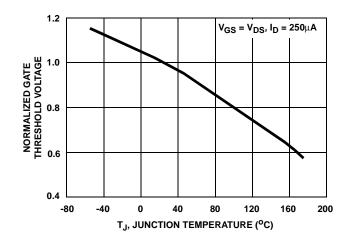
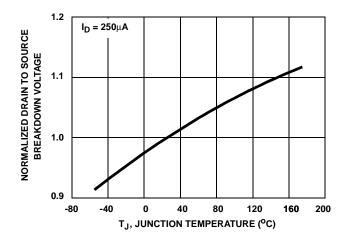


FIGURE 10. NORMALIZED GATE THRESHOLD VOLTAGE vs JUNCTION TEMPERATURE

### Typical Performance Curves (Continued)



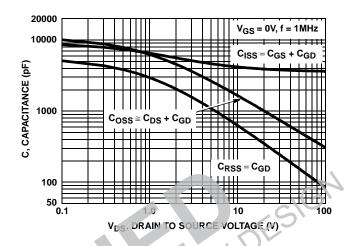
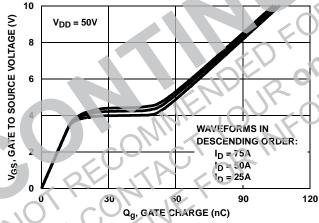


FIGURE 11. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

FIGURE 12. CAPACITANCE VS DRAIN TO SOURCE VOLTAGE



NOTE: Refer to ON Semiconductor Application Notes AN7254 and AN7260.

FIGURE 13. GATE CHARGE WAVEFORMS FOR CONSTANT GATE CURRENT

### Test Circuits and Waveforms

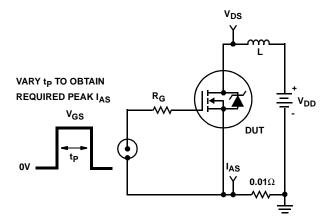


FIGURE 14. UNCLAMPED ENERGY TEST CIRCUIT

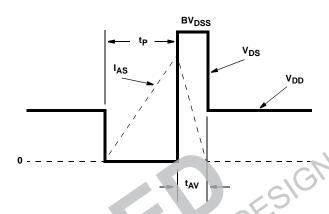


FIGURE 15. UNCLAMPED ENERGY WAVEFORMS

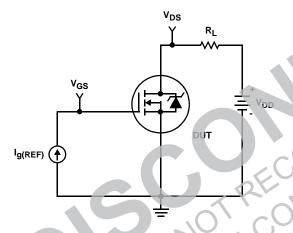


FIGURE 16. GATE CHARGE TEST CIRCUIT

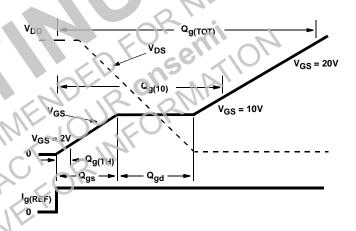


FIGURE 17. GATE CHARGE WAVEFORMS

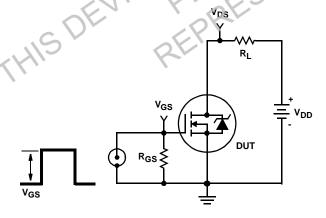


FIGURE 18. SWITCHING TIME TEST CIRCUIT

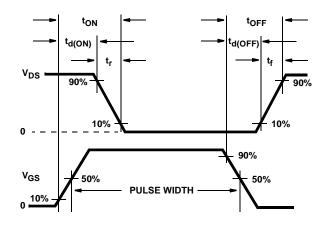
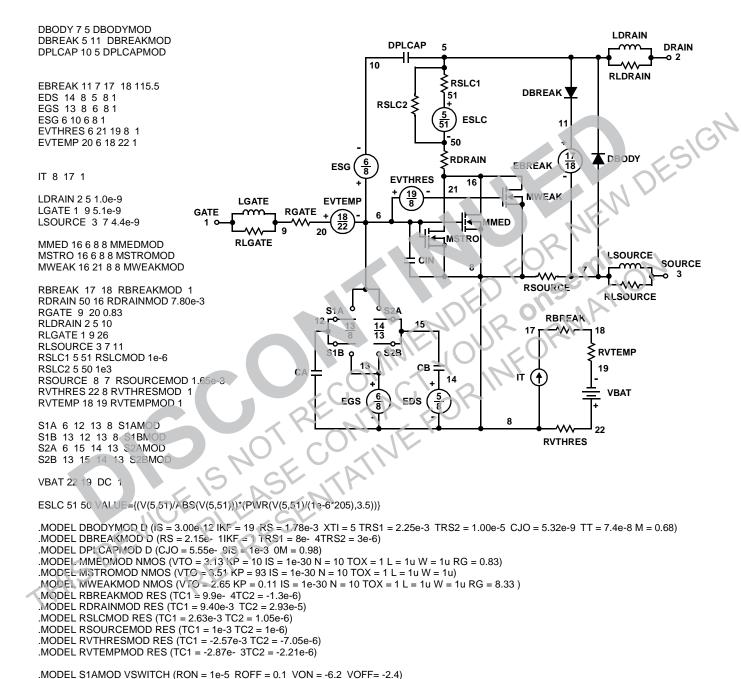


FIGURE 19. SWITCHING TIME WAVEFORM

#### **PSPICE Electrical Model**

.SUBCKT HUF75645 2 1 3; rev 21 May 1999

CA 12 8 5.31e-9 CB 15 14 5.31e-9 CIN 6 8 3.56e-9



.ENDS

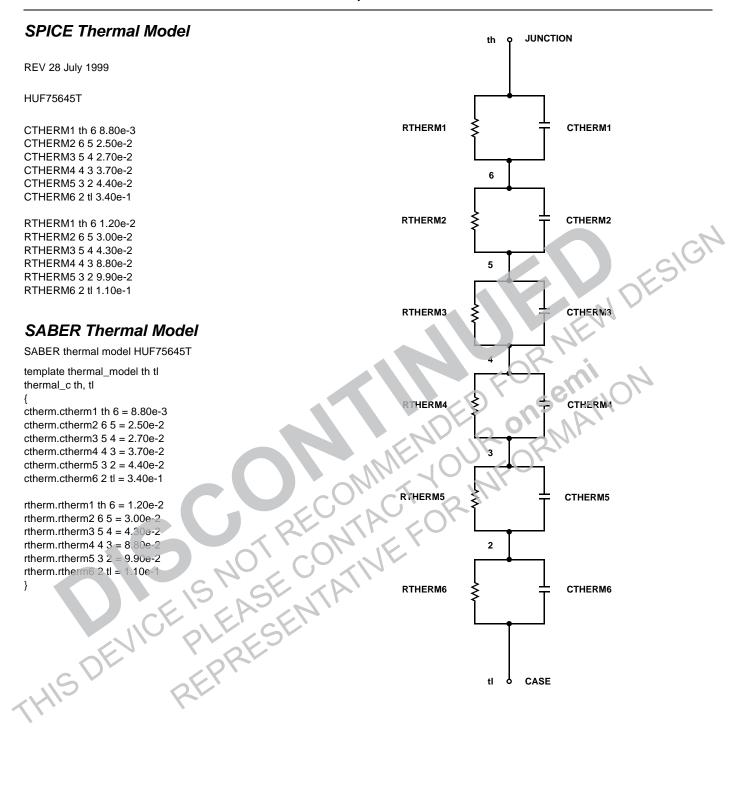
NOTE: For further discussion of the PSPICE model, consult **A New PSPICE Sub-Circuit for the Power MOSFET Featuring Global Temperature Options**; IEEE Power Electronics Specialist Conference Records, 1991, written by William J. Hepp and C. Frank Wheatley.

.MODEL S1BMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -2.4 VOFF= -6.2) .MODEL S2AMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = -1.8 VOFF= 0.5) .MODEL S2BMOD VSWITCH (RON = 1e-5 ROFF = 0.1 VON = 0.5 VOFF= -1.8)

#### SABER Electrical Model

```
REV 21 May 1999
template ta75645 n2,n1,n3
electrical n2,n1,n3
var i iscl
d..model dbodymod = (is = 3.00e-12, cjo = 5.32e-9, tt = 7.4e-8, xti = 5, m = 0.68)
d..model dbreakmod = ()
d..model dplcapmod = (cjo = 5.55e-9, is = 1e-30, vj=1.0, m = 0.8)
m..model mmedmod = (type=_n, vto = 3.13, kp = 10, is = 1e-30, tox = 1)
m..model mstrongmod = (type=_n, vto = 3.51, kp = 93, is = 1e-30, tox = 1)
m..model mweakmod = (type=_n, vto = 2.65, kp = 0.11, is = 1e-30, tox = 1)
                                                                                                                                   LDRAIN
sw_vcsp..model s1amod = (ron = 1e-5, roff = 0.1, von = -6.2, voff = -2.4)
                                                                                   DPLCAP
                                                                                                                                             DRAIN
sw_vcsp..model s1bmod = (ron =1e-5, roff = 0.1, von = -2.4, voff = -6.2)
sw_vcsp..model s2amod = (ron = 1e-5, roff = 0.1, von = -1.8, voff = 0.5)
                                                                                10
                                                                                                                                  RLDRAIN
sw_vcsp..model s2bmod = (ron = 1e-5, roff = 0.1, von = 0.5, voff = -1.8)
                                                                                                 RSLC1
                                                                                                             RDBREAK
                                                                                                51
c.ca n12 n8 = 5.31e-9
                                                                                 RSLC2 €
c.cb n15 n14 = 5.31e-9
                                                                                                                                  RDBODY
                                                                                                  ISCL
c.cin n6 n8 = 3.56e-9
                                                                                                               DBREAK .
d.dbody n7 n71 = model=dbodymod
                                                                                                RDRAIN
d.dbreak n72 n11 = model=dbreakmod
                                                                             6
8
                                                                       ESG
d.dplcap n10 n5 = model=dplcapmod
                                                                                    EVTHRES
                                                                                                    16
                                                                                                 21
                                                                                       19
8
                                                                                                                WWEAK
i.it n8 n17 = 1
                                                    LGATE
                                                                      EVTEMP
                                                                                                                                  DBODY
                                                             RGATE
                                           GATE
                                                                        18
22
                                                                                                                 EBREAK
I.ldrain n2 n5 = 1e-9
                                                                                                         IMED
                                                            9
                                                                    20
I.lgate n1 n9 = 5.1e-9
                                                                                                MSTRO
                                                   RLGATE
I.Isource n3 n7 = 4.4e-9
                                                                                                                                  LSOURCE
                                                                                          CIN
                                                                                                                                             SOURCE
m.mmed n16 n6 n8 n8 = model=mmedmod, l=1u, w=1u
m.mstrong n16 n6 n8 n8 = model=mstrongmod, l=1u, w=1u
                                                                                                                RSOURCE
m.mweak n16 n21 n8 n8 = model=mweakmod, l=1u, w=1u
                                                                                                                                 RLSOURCE
                                                                      S1A
res.rbreak n17 n18 = 1, tc1 = 9.9e-4, tc2 = -1.3e-6
                                                                                                                    RBREAK
res.rdbody n71 n5 = 1.78e-3, tc1 = 2.25e-3, tc2 = 1.6e-3
res.rdbreak n72 n5 = 2.15e-1, tc1 = 8e-4, tc2 = 3e-6
                                                                                                                                RVTEMP
res.rdrain n50 n16 = 7.8e-3, tc1 = 9.4e-3, tc2 = 2.93e-5
                                                                      S<sub>1</sub>B
                                                                                  S2B
res.rgate n9 n20 = 0.83
                                                                                                                                19
res.rldrain n2 n5 = 10
                                                                                                                  ♠
                                                                                                              IT
res.rlgate n1 n9 = 26
                                                                                                                                  VBAT
res.rlsource n3 n7 = 11
res.rslc1 n5 n51 = 1e-6, tc1 = 2.63e-3, tc2 =
                                                                                                            8
res.rslc2 n5 n50 = 1e3
res.rsource n8 n7
                    1.65e-3, tc1 = 1e-3, tc2 = 1e-6
                                                                                                                    RVTHRES
res.rvtemp n18 n19 = 1, tc1 = -2.87e-3, tc2 = -2.21e-6 res.rvthres n22 n8 = 1, to1 = -2.57e-3, tc2 = -7.05e-6
                                                     SENTA
spe.ebreak n11 n7 n17 n18 = 115.5
spe.eds n14 \, n8 \, n5 \, n8 = 1
spe.eqs n13 \, n8 \, n6 \, n8 = 1
spe.esg n6 n10 n6 n8 = 1
spe.evtemp n20 n6 n13 n22 = 1
spe.evthres n6 n21 n19 n8 = 1
sw_vcsp.s1a no n12 n13 n8 = model=s1amod
sw_vccp.s1o n13 n12 n13 n8 = model=s1omod
sw_vcsp.s2a n6 n15 n14 n13 = model=s2amod
sw_vcsp.s2b n13 n15 n14 n13 = model=s2bmod
v.vbat n22 n19 = dc=1
equations {
i (n51->n50) +=iscl
iscl: v(n51,n50) = ((v(n5,n51)/(1e-9+abs(v(n5,n51))))*((abs(v(n5,n51)*1e6/205))** 3.5))
```

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